

NEW

Chip Attenuator 0404

Type: **EXB24AT (Unbalanced π type)**

Type: **EXB24AB (Balanced O type)**



■ Features

EXB24AT type : Unbalanced π type

- Unbalanced π type attenuator circuit in one chip(1.0 mm × 1.0 mm)
- Mounting occupation area reduction : about 50 % reduction compared with an attenuator circuit consisting of three 0402 chip resistors, almost equal to an attenuator circuit consisting of three 0201 chip resistors
- Mounting cost reduction : Mounting times 3 times → 1 time
- Attenuation : 1 dB to 10 dB

EXB24AB type : Balanced O type

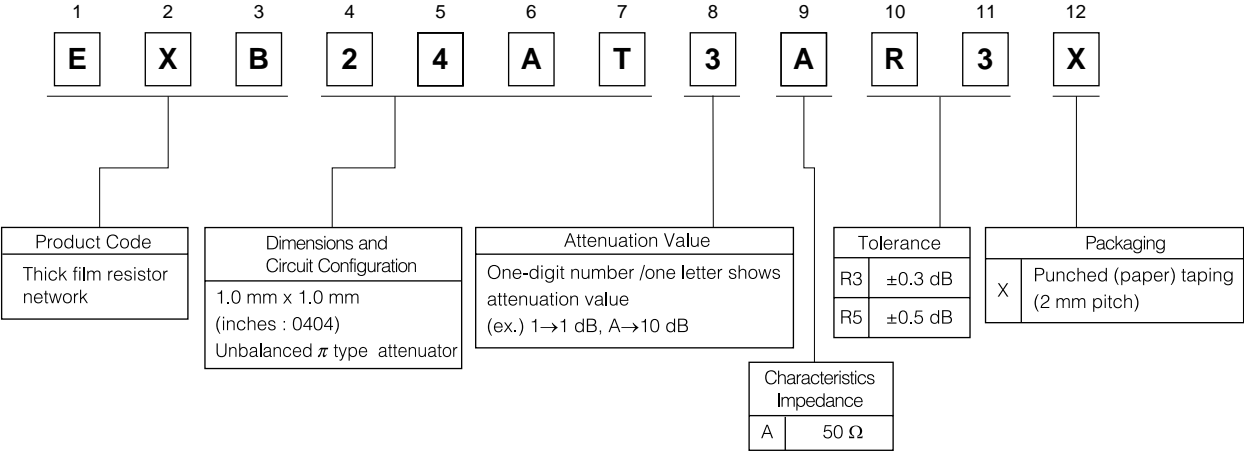
- Balanced O type attenuator circuit in one chip(1.0 mm × 1.0 mm)
- Mounting occupation area reduction : about 64 % reduction compared with an attenuator circuit consisting of four 0402 chip resistors, about 26 % reduction compared with attenuator circuit consisting of four 0201 chip resistors
- Mounting cost reduction : Mounting times 4 times → 1 time
- Attenuation : 0 dB to 10 dB

■ Recommended Applications

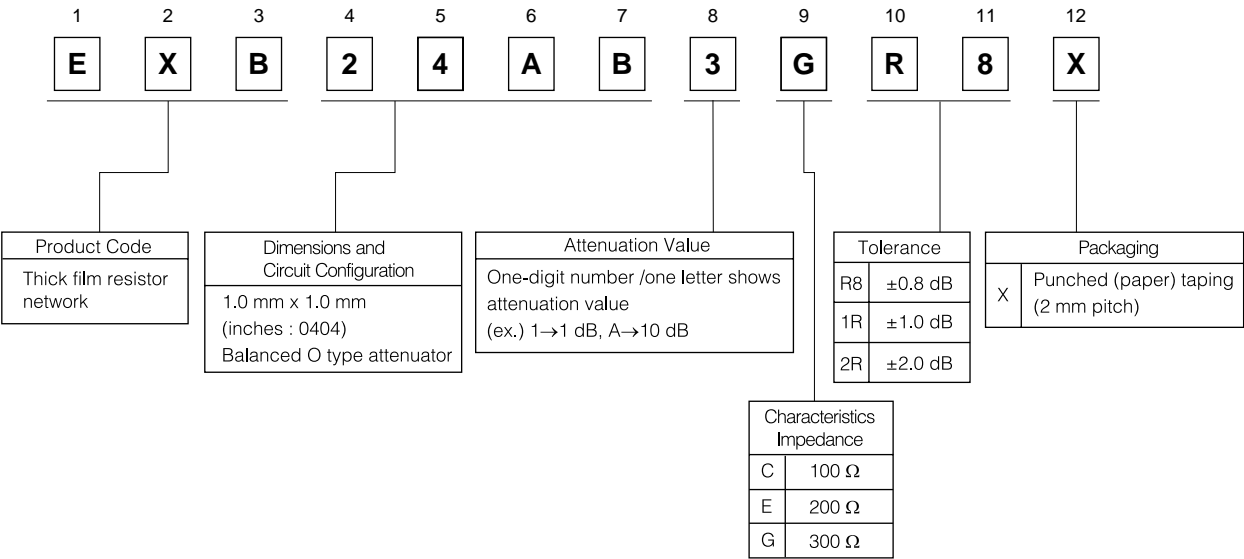
- Attenuation / level control / impedance matching of high frequency signals of communication equipment; cellular phones(GSM, CDMA, PDC, etc.), PHS, PDA, for example.

■ Explanation of Part Numbers

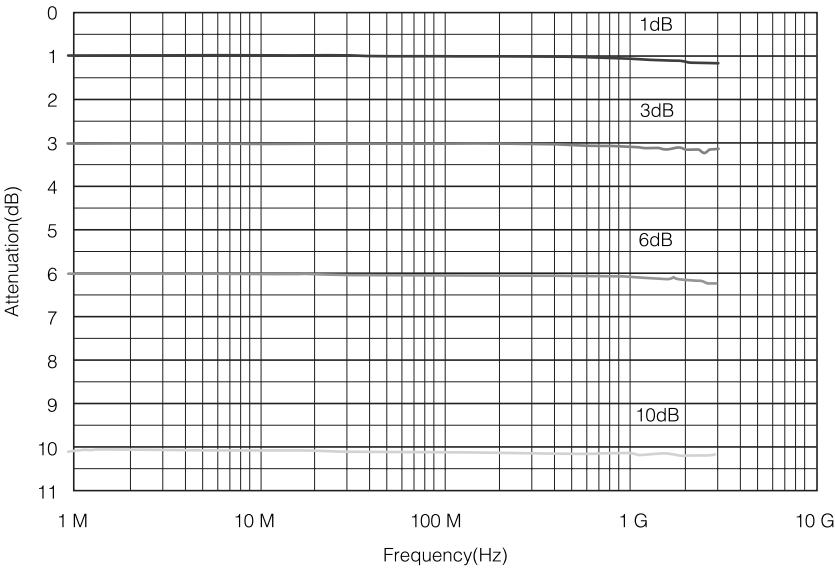
● EXB24AT type : Unbalanced π type



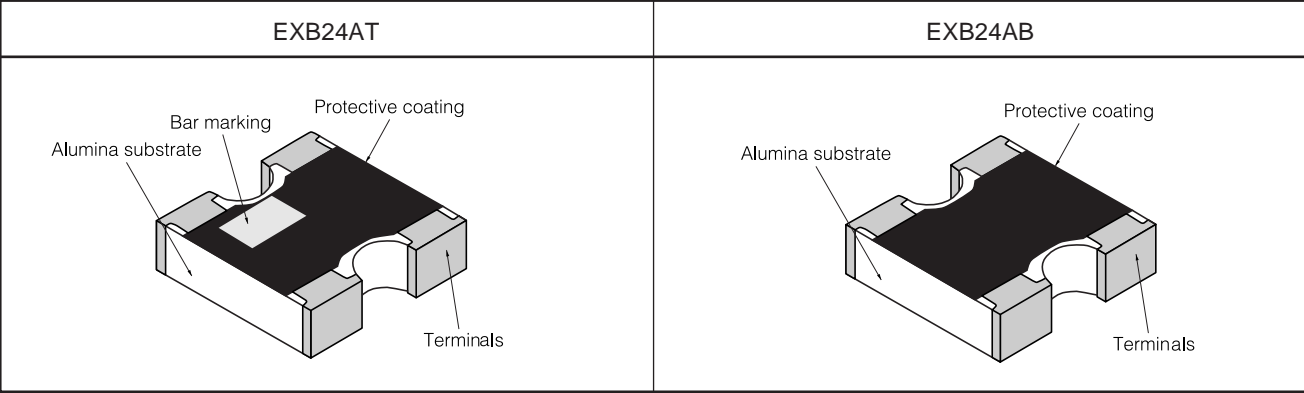
● EXB24AB type : Balanced O type



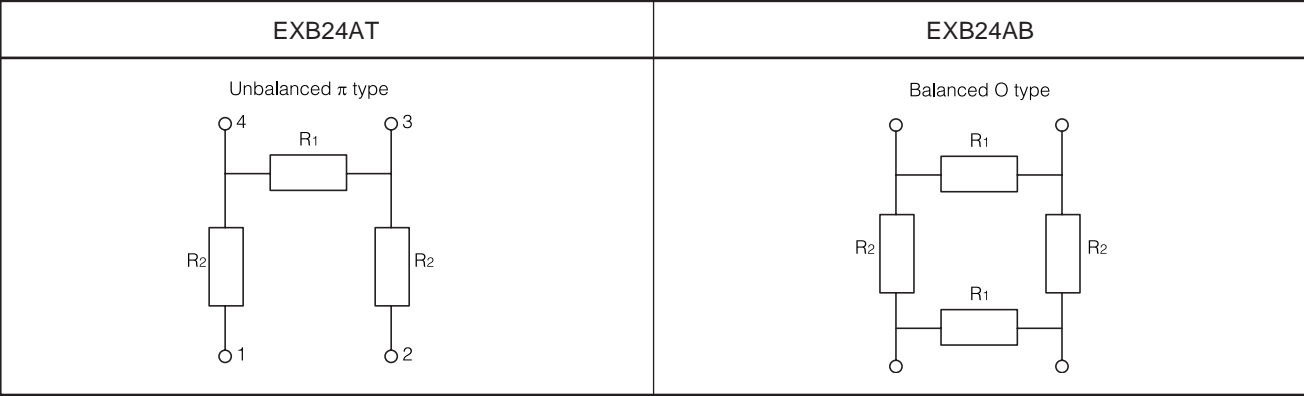
■ Attenuation-Frequency Characteristics (typical) (EXB24AT type)



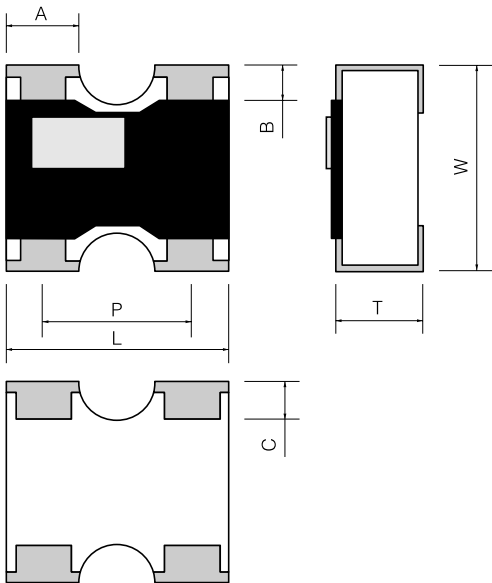
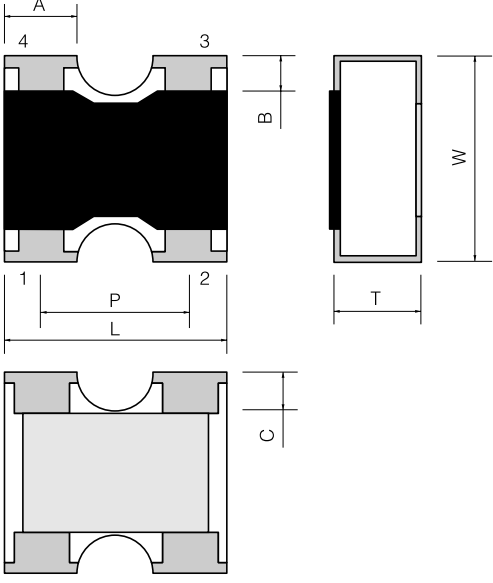
Construction



Circuit Configuration



Dimensions (not to scale)

EXB24AT	EXB24AB																																				
																																					
<table border="1"><tr><td>Dimensions (mm)</td><td>L</td><td>W</td><td>T</td><td>A</td><td>B</td></tr><tr><td></td><td>1.00\pm0.10</td><td>1.00\pm0.10</td><td>0.35\pm0.10</td><td>0.33\pm0.10</td><td>0.15\pm0.10</td></tr></table> <table border="1"><tr><td>Dimensions (mm)</td><td>C</td><td>P (typical value)</td></tr><tr><td></td><td>0.25\pm0.10</td><td>0.65</td></tr></table> <p><Marking Configuration> The bar marking for recognizing terminal direction is located on the side of terminal 4.</p>	Dimensions (mm)	L	W	T	A	B		1.00 \pm 0.10	1.00 \pm 0.10	0.35 \pm 0.10	0.33 \pm 0.10	0.15 \pm 0.10	Dimensions (mm)	C	P (typical value)		0.25 \pm 0.10	0.65	<table border="1"><tr><td>Dimensions (mm)</td><td>L</td><td>W</td><td>T</td><td>A</td><td>B</td></tr><tr><td></td><td>1.00\pm0.10</td><td>1.00\pm0.10</td><td>0.35\pm0.10</td><td>0.33\pm0.10</td><td>0.15\pm0.10</td></tr></table> <table border="1"><tr><td>Dimensions (mm)</td><td>C</td><td>P (typical value)</td></tr><tr><td></td><td>0.30\pm0.10</td><td>0.65</td></tr></table>	Dimensions (mm)	L	W	T	A	B		1.00 \pm 0.10	1.00 \pm 0.10	0.35 \pm 0.10	0.33 \pm 0.10	0.15 \pm 0.10	Dimensions (mm)	C	P (typical value)		0.30 \pm 0.10	0.65
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Design, Specifications are subject to change without notice. Ask factory for technical specifications before purchase and/or use. Whenever a doubt about safety arises from this product, please inform us immediately for technical consultation without fail.

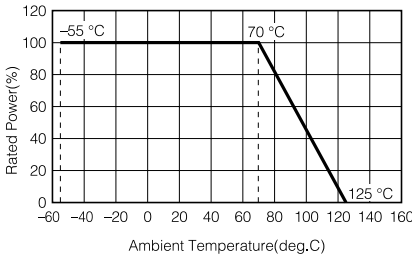
■ Ratings

Item	EXB24AT	EXB24AB
Attenuation Value	1 dB, 2 dB, 3 dB, 4 dB, 5 dB, 6 dB, 10 dB*	0 dB, 1 dB, 2 dB, 3 dB, 6 dB, 10 dB*
Attenuation Value Tolerance	1 dB, 2 dB, 3 dB, 4 dB, 5 dB : ± 0.3 dB 6 dB, 10 dB : ± 0.5 dB	0 dB to 3 dB : ± 0.8 dB 6 dB : ± 1.0 dB 10 dB : ± 2.0 dB
Characteristic Impedance	50 Ω *	100 Ω , 200 Ω , 300 Ω *
Power Rating	0.04 W /package	0.04 W /package
Frequency Range	DC to 2 GHz	DC to 2.5 GHz
VSWR (Voltage Standing Wave Ratio)	1.3 Max.	1.2 Max.(typical value) 1.5 Max.(0 dB, typical value)
Number of Resistors	3 resistors	4 resistors
Number of Terminals	4 terminals	4 terminals
Category Temperature Range (Operating Temperature Range)	-55 °C to +125 °C	-55 °C to +125 °C

*Please inquire about the other attenuator value / characteristics impedance.

Power Derating Curve

For resistors operated in ambient temperature above 70°C, power rating shall be derated in accordance with the figure on the right.



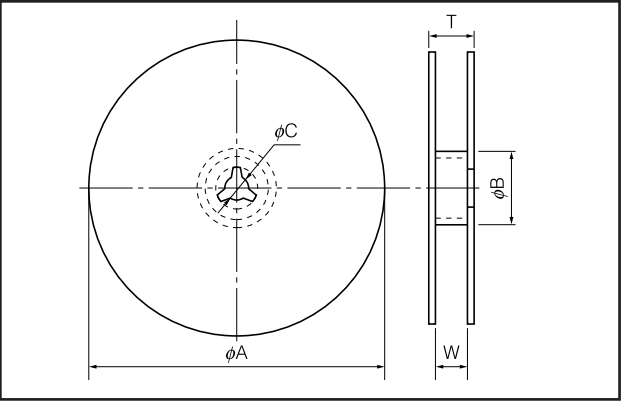
■ Packaging Methods

● Standard Quantity

Type (inches)	Thickness (mm)	Weight (mg)	Punched (Paper) Taping (2 mm Pitch)
EXB24AT/AB (0404)	0.35	1.1	10000 pcs./reel

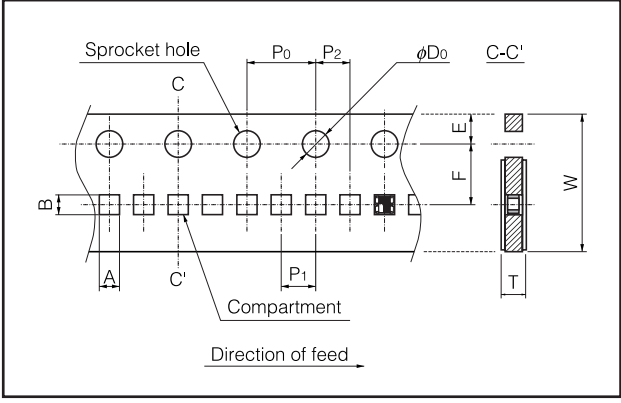
■ Taping Dimensions

● Taping Reel



Dimensions (mm)	φA	φB	φC	W	T
	180.0 $^{+0.0}_{-3.0}$	60 min.	13.0 ± 1.0	9.0 ± 1.0	11.4 ± 2.0

● Punched (Paper) Taping

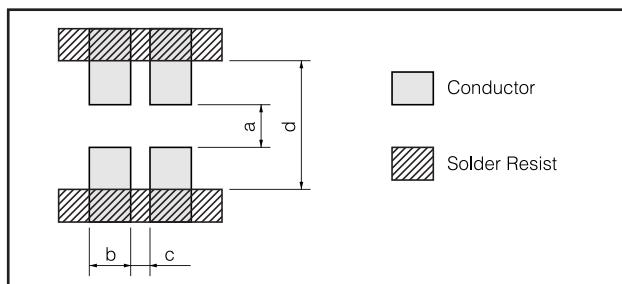


Dimensions (mm)	A	B	W	F	E
	1.20 ± 0.05	1.20 ± 0.05	8.00 ± 0.20	3.50 ± 0.05	1.75 ± 0.10

Dimensions (mm)	P ₀	P ₁	P ₂	φD ₀	T
	4.00 ± 0.10	2.00 ± 0.10	2.00 ± 0.05	1.50 $^{+0.10}_{0}$	0.45 ± 0.10

<Product direction in the chip pocket of carrier tape>
Products shall be sealed so as to locate the terminal 1 and 2 on the side of feeding direction in the chip pocket.

Recommend Land Pattern



Dimensions (mm)	a	b	c	d
	0.5	0.35 to 0.4	0.3	1.4 to 1.5

Safety Precautions

1. Soldering

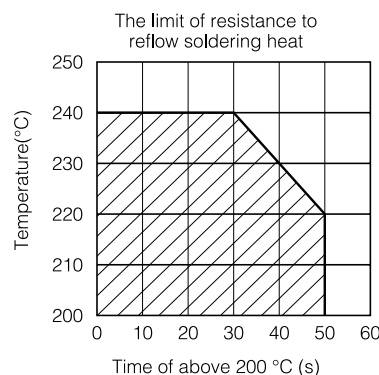
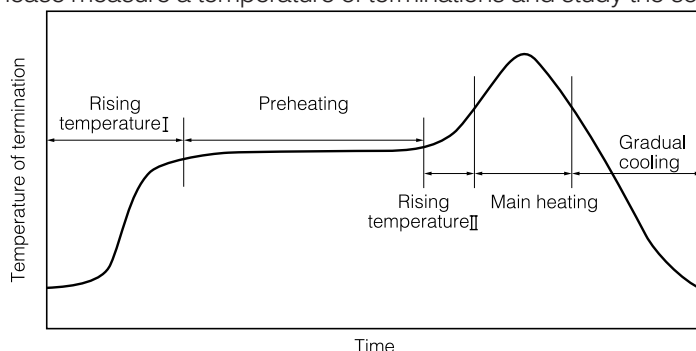
Recommendation for soldering method is noted below.

● Reflow soldering

Precautions and recommendations are described below.

● Please inquire with us when you use the different conditions.

● Please measure a temperature of terminations and study the solderability for every type of board before using.



Rising temperature I	The normal to Preheating temperature	30 s to 60 s
Preheating	140 °C to 160 °C	60 s to 120 s
Rising temperature II	Preheating to 200 °C	20 s to 40 s
Main heating	(cf. The limits of resistance to reflow soldering heat)	
Gradual cooling	200 °C to 100 °C	1 °C/s to 4 °C/s

(Reflow soldering shall be within two times.)

● Flow soldering

We cannot recommend the flow soldering, because a solder bridge may occur owing to narrow 0.65 mm pitch.

● Iron soldering

① Solder at 280 °C max. and 3 seconds max. with the soldering iron tip.

② The soldering iron tip shall not touch the protective coating of the part.

● Use rosin type flux. Do not use high-activity flux (the chlorine content is 0.2 wt % or more).

● Allow enough preheating so that the difference of soldering temperature and temperature of surface of the part is 100 °C or less. This temperature difference shall be kept in rapid cooling by immersion into solvent.

● Use of more solder results in more mechanical stress to the part resulting in cracking or impaired characteristics. Avoid excessive amount of solder.

2. Cleaning

● Residual flux after board washing may cause solder migration. Carefully check the status of board washing.

Study the type and amount of flux to be used when no washing is made. Study the type of water-soluble flux and cleaning agent and drying condition when water washing is done. Confirm they will not cause any trouble.

3. Others

● Take necessary precautions to avoid any abnormal stress caused by bending of board.

● Do not use the product in dewy atmosphere.

AMEYA360

Components Supply Platform

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